

**Amendments to the Specification:**

Please insert the following paragraph at page 1, line 5:

This application is a divisional of application Serial No. 09/786735, filed March 8, 2001, which is a 371 of PCT/JP99/04828, filed 06 September 1999, which application(s) are incorporated herein by reference.

Please replace the paragraph beginning at page 11, line 18 with the following amended paragraph:

Furthermore, a management area 10 where information about the type of recording medium, recording conditions, or the like has been recorded is provided in the inner circumference of the recording medium. A disk identifier 11 for identifying the sector position of the first information layer 2 is provided in the area other than the data area 8, the sector address 9, and the management area 10. The disk identifier 11 is located so as to have a certain relationship to the sector address [[11]] 9. In this embodiment, the disk identifier 11 is formed in the inner circumference of the management area 10.

Please replace the paragraph beginning at page 12, line 10 with the following amended paragraph:

FIGS. 2(b) and 2(d) show the amplitude of the reproduced signals from the second information layer 4 and correspond to FIGS. 2 (a) and 2(c), respectively. When the first information layer 2 is not recorded, the reproduced signals are the same as the conventional signals, as shown in FIG. 2(b). On the other hand, when the first information layer 2 is recorded, the amplitude of the reproduced signals is increased because of the recorded state of the first information layer 2, as shown in FIG. 2(d). However, since the positions of the sector addresses 9, [[14]] 13 of the respective information layers 2, 4 coincide, the amplitude level of the signals in the data information

area is unchanged. As a result, information signals recoded on the second information layer 4 can be demodulated stably.

Please replace the paragraph beginning at page 14, line 7 with the following amended paragraph:

FIG. 4(c) shows a coating step of coating the surface of the ~~first information layer 2~~ second information layer 4 with an adhesive 44, which results in an adhesion layer. In this process, an ultraviolet curable resin is used as the adhesive 44. FIG. 4(d) shows a bonding step of bonding the first information layer 2 on the first substrate 1 and the second information layer 4 on the second substrate 41 together via the adhesive 44. The substrates are rotated or pressurized so that the thickness of the adhesive 44 between the substrates 1 and 41 is uniform, if necessary.